

<b>Notice of References Cited</b>	Application/Control No. 10/628,941	Applicant(s)/Patent Under Reexamination FRATTI ET AL.	
	Examiner Thomas J. Magee	Art Unit 2811	Page 1 of 1

**U.S. PATENT DOCUMENTS**

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
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	B	US-6,162,665	12-2000	Nathan Zommer	438/133
	C	US-5,847,283	12-1998	Marc Finot et al.	73/812
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	K	US-			
	L	US-			
	M	US-			

**FOREIGN PATENT DOCUMENTS**

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**NON-PATENT DOCUMENTS**

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	U	Syd R. Wilson, Clarence J. Tracy, and John L. Freeman, Jr., "Handbook of Multilevel Metallization for Integrated Circuits," Noyes Publ., (1993), pp. 223 -225.
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\*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)  
Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.